# **Dual D-Type Flip-Flop** with Set and Clear

With 5.0 V-Tolerant Inputs

# MC74LVX74

The MC74LVX74 is an advanced high speed CMOS D-type flip-flop. The inputs tolerate voltages up to 6.5 V, allowing the interface of 5.0 V systems to 3.0 V systems.

The signal level applied to the D input is transferred to O output during the positive going transition of the Clock pulse.

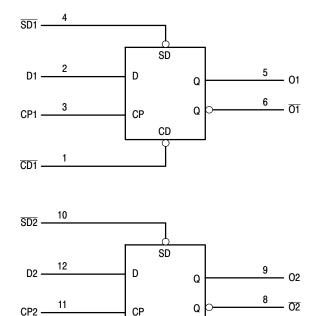
Clear (CD) and Set (SD) are independent of the Clock (CP) and are accomplished by setting the appropriate input Low.

# Features

- High Speed:  $f_{max} = 145$  MHz (Typ) at  $V_{CC} = 3.3$  V
- Low Power Dissipation:  $I_{CC} = 2 \mu A$  (Max) at  $T_A = 25^{\circ}C$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Low Noise:  $V_{OLP} = 0.5 V (Max)$
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance:

Human Body Model > 2000 V

• These Devices are Pb-Free and are RoHS Compliant





CD



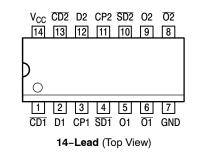
D SUFFIX

CASE 751A

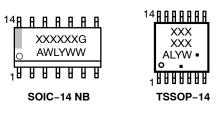


TSSOP-14 DT SUFFIX **CASE 948G** 

#### **PIN ASSIGNMENT**







XXX	= Specific Device Code
А	= Assembly Location
WL, L	= Wafer Lot
Y	= Year
W, WW	= Work Week
G or ∎	= Pb-Free Package

(Note: Microdot may be in either location)

PIN NAMES						
Pins	Function					
CP1, CP2 D1, D2 CD1, CD2 SD1, SD2 On, On	Clock Pulse Inputs Data Inputs Direct Clear Inputs Direct Set Inputs Outputs					

# **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

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CD2

	INPUTS				PUTS	
SDn	CDn	CPn	Dn	On	On	OPERATING MODE
L H	H L	X X	X X	H L	L H	Asynchronous Set Asynchronous Clear
L	L	х	х	н	н	Undetermined
H H	H H	$\uparrow \\ \uparrow$	h I	H L	L H	Load and Read Register
Н	Н	1	Х	NC	NC	Hold

H = High Voltage Level; h = High Voltage Level One Setup Time Prior to the Low-to-High Clock Transition; L = Low Voltage Level; I = Low Voltage Level One Setup Time Prior to the Low-to-High Clock Transition; NC = No Change; X = High or Low Voltage Level or Transitions are Acceptable;  $\uparrow$  = Low-to-High Transition;  $\uparrow$  = Not a Low-to-High Transition; For I<sub>CC</sub> Reasons DO NOT FLOAT Inputs

## MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage	-0.5 to +6.5	V
V <sub>in</sub>	DC Input Voltage	–0.5 to +6.5	V
V <sub>out</sub>	DC Output Voltage	–0.5 to V <sub>CC</sub> +0.5	V
Ι <sub>ΙΚ</sub>	Input Diode Current	-20	mA
I <sub>OK</sub>	Output Diode Current	±20	mA
I <sub>out</sub>	DC Output Current, per Pin	±25	mA
I <sub>CC</sub>	DC Supply Current, V <sub>CC</sub> and GND Pins	±50	mA
P <sub>D</sub>	Power Dissipation SOIC TSSOP	1077 833	mW
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	DC Supply Voltage	2.0	3.6	V
V <sub>in</sub>	DC Input Voltage	0	5.5	V
V <sub>out</sub>	DC Output Voltage	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature, All Package Types	-40	+85	°C
$\Delta t / \Delta V$	Input Rise and Fall Time	0	100	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### **DC ELECTRICAL CHARACTERISTICS**

			v <sub>cc</sub>	٦	r <sub>A</sub> = 25°0	)	T <sub>A</sub> = - 40	) to 85°C	
Symbol	Parameter	Test Conditions	V	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	High-Level Input Voltage		2.0 3.0 3.6	1.5 2.0 2.4			1.5 2.0 2.4		V
V <sub>IL</sub>	Low-Level Input Voltage		2.0 3.0 3.6			0.5 0.8 0.8		0.5 0.8 0.8	V
V <sub>OH</sub>	High-Level Output Voltage (V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub> )	$I_{OH} = -50\mu A$ $I_{OH} = -50\mu A$ $I_{OH} = -4mA$	2.0 3.0 3.0	1.9 2.9 2.58	2.0 3.0		1.9 2.9 2.48		V
V <sub>OL</sub>	Low-Level Output Voltage (V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub> )	$I_{OL} = 50\mu A$ $I_{OL} = 50\mu A$ $I_{OL} = 4m A$	2.0 3.0 3.0		0.0 0.0	0.1 0.1 0.36		0.1 0.1 0.44	V
l <sub>in</sub>	Input Leakage Current	V <sub>in</sub> = 5.5V or GND	3.6			±0.1		±1.0	μA
I <sub>CC</sub>	Quiescent Supply Current	$V_{in} = V_{CC}$ or GND	3.6			2.0		20.0	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **AC ELECTRICAL CHARACTERISTICS** (Input $t_r = t_f = 3.0$ ns)

				ſ	Γ <sub>A</sub> = 25°C	>	$T_A = -40$	) to 85°C	
Symbol	Parameter	Test Cond	itions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay CP to O or $\overline{O}$	V <sub>CC</sub> = 2.7V	C <sub>L</sub> = 15pF C <sub>L</sub> = 50pF		7.3 9.8	15.0 18.5	1.0 1.0	18.5 22.0	ns
		$V_{CC}=3.3\pm0.3V$	C <sub>L</sub> = 15pF C <sub>L</sub> = 50pF		5.7 8.2	9.7 13.2	1.0 1.0	11.5 15.0	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay SD or CD to O or O	V <sub>CC</sub> = 2.7V	C <sub>L</sub> = 15pF C <sub>L</sub> = 50pF		8.4 10.9	15.6 19.1	1.0 1.0	18.5 22.0	ns
		$V_{CC}=3.3\pm0.3V$	C <sub>L</sub> = 15pF C <sub>L</sub> = 50pF		6.6 9.1	10.1 13.6	1.0 1.0	12.0 15.5	
f <sub>max</sub>	Maximum Clock Frequency (50% Duty Cycle)	V <sub>CC</sub> = 2.7V	C <sub>L</sub> = 15pF C <sub>L</sub> = 50pF	55 45	135 60		50 40		MHz
		$V_{CC}=3.3\pm0.3V$	C <sub>L</sub> = 15pF C <sub>L</sub> = 50pF	95 60	145 85		80 50		
t <sub>OSHL</sub> t <sub>OSLH</sub>	Output-to-Output Skew (Note 1)		C <sub>L</sub> = 50pF C <sub>L</sub> = 50pF			1.5 1.5		1.5 1.5	ns

 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

#### **TIMING REQUIREMENTS** (Input t<sub>r</sub> = t<sub>f</sub> = 3.0ns)

		v <sub>cc</sub>	Guarantee	ed Limit	
Symbol	Parameter	v	T <sub>A</sub> = 25°C	T <sub>A</sub> = −40 to 85°C	Unit
t <sub>w</sub>	Minimum Pulse Width, CP	2.7V 3.3V ±0.3	8.5 6.0	10.0 7.0	ns
t <sub>w</sub>	Minimum Pulse Width, $\overline{CD}$ or $\overline{SD}$	2.7V 3.3V ±0.3	8.5 6.0	10.0 7.0	ns
t <sub>su</sub>	Minimum Setup Time, D to CP	2.7V 3.3V ±0.3	8.0 5.5	9.5 6.5	ns
t <sub>h</sub>	Minimum Hold Time, D to CP	2.7V 3.3V ±0.3	0.5 0.5	0.5 0.5	ns
t <sub>rec</sub>	Minimum Recovery Time, SD or CD to CP	2.7V 3.3V ±0.3	6.5 5.0	7.5 5.0	ns

# **CAPACITIVE CHARACTERISTICS**

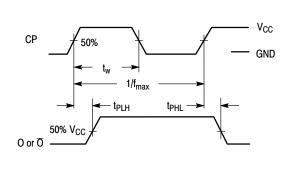
		T <sub>A</sub> = 25°C		$T_A = -40$ to $85^{\circ}C$			
Symbol	Parameter	Min	Тур	Max	Min	Max	Unit
Cin	Input Capacitance		4	10		10	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 2)		25				pF

2.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}/2$  (per flip-flop).  $C_{PD}$  is used to determine the no-load dynamic power consumption;  $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$ .

# **NOISE CHARACTERISTICS** (Input $t_r = t_f = 3.0$ ns, $C_L = 50$ pF, $V_{CC} = 3.3$ V, Measured in SOIC Package)

		T <sub>A</sub> =		
Symbol	Characteristic	Тур	Max	Unit
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	0.3	0.5	V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	-0.3	-0.5	V
V <sub>IHD</sub>	Minimum High Level Dynamic Input Voltage		2.0	V
V <sub>ILD</sub>	Maximum Low Level Dynamic Input Voltage		0.8	V

# SWITCHING WAVEFORMS



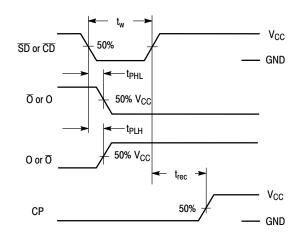


Figure 2.



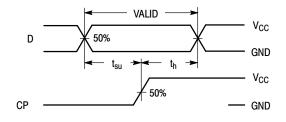
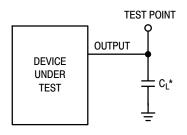


Figure 4.

# **TEST CIRCUIT**



\*Includes all probe and jig capacitance

Figure 5.

## **ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
MC74LVX74DR2G	LVX74	SOIC-14	2500 Tape & Reel
MC74LVX74DTR2G	LVX 74	TSSOP-14	2500 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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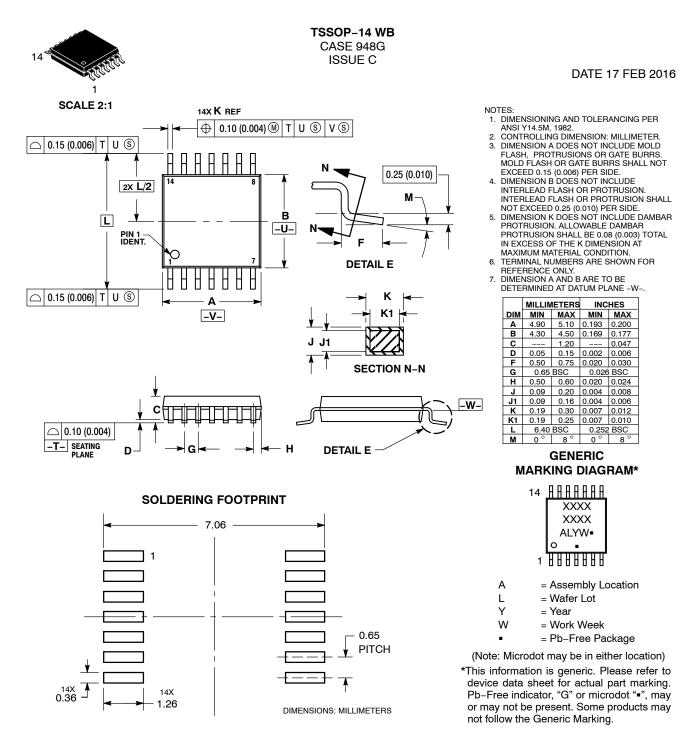
STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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